
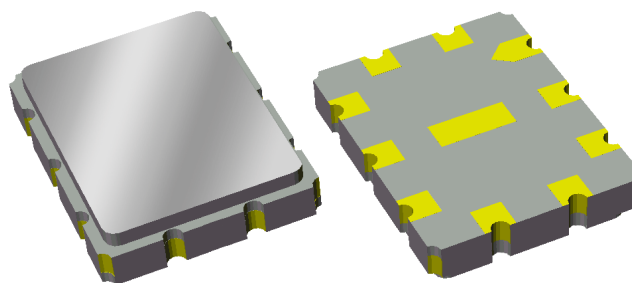


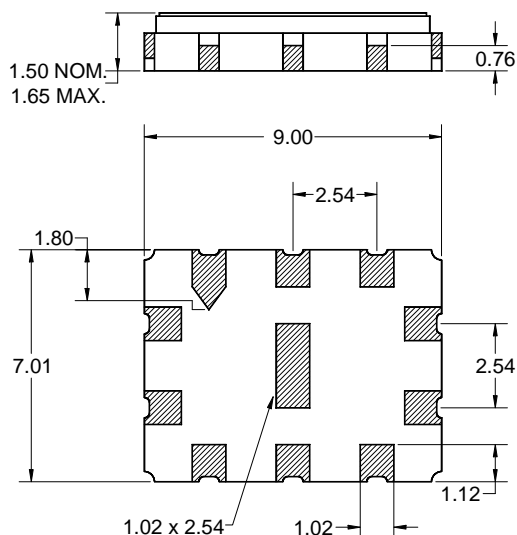
Features

- For broadband applications
- Typical 3dB bandwidth of 65 MHz
- High attenuation
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Replaces Sawtek P/N 851948 (BW 3dB=64 MHz)
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free 



Package

Surface Mount 9.00 x 7.01 x 1.50 mm
SMP-35B

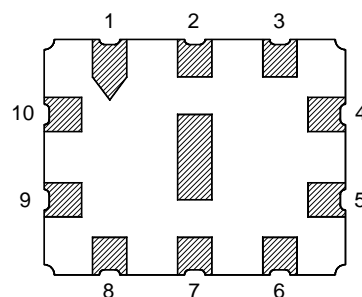


Dimensions shown are nominal in millimeters
All tolerances are ± 0.15 mm except overall
length and width $+0.10$ mm / -0.15 mm

Body: Al_2O_3 ceramic
Lid: Kovar, Ni plated
Terminations: Au plating 0.5 - 1.0 μ m,
over a 2 - 6 μ m Ni plating

Pin Configuration

Bottom View



Single-ended Configuration

Pin No.	Description
4	Output
5	Output return
9	Input
10	Input return
1,2,3,6,7,8	Case ground

Electrical Specifications ⁽¹⁾

Operating Temperature Range: ⁽²⁾ 0 to +70 °C

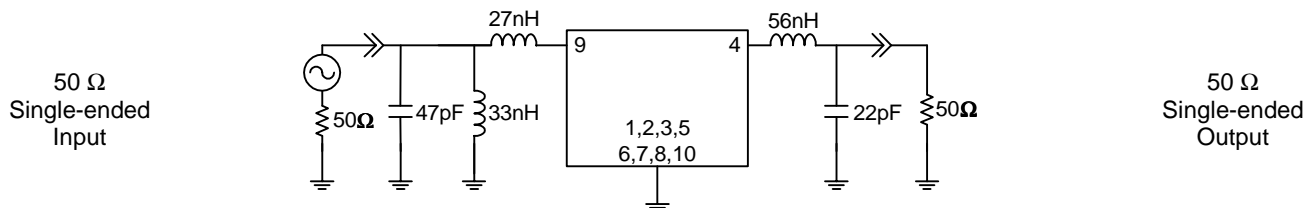
Parameter ⁽³⁾	Minimum	Typical ⁽⁴⁾	Maximum	Unit
Center Frequency	-	140	-	MHz
Minimum Insertion Loss	-	17.8	20	dB
Lower 1 dB Bandedge ⁽⁵⁾	-	108.85	111.75	MHz
Upper 1 dB Bandedge	168.25	170.27	-	MHz
Lower 3 dB Bandedge ⁽⁵⁾	-	107.45	108.5	MHz
Upper 3 dB Bandedge	171.5	172.61	-	MHz
Lower 40 dB Bandedge ⁽⁵⁾	98	102.35	-	MHz
Upper 40 dB Bandedge	-	180.78	182	MHz
Amplitude Variation 111.75 - 168.25 MHz	-	0.6	1.0	dB p-p
Phase Linearity 111.75 - 168.25 MHz	-	5.35	10	deg p-p
Group Delay Variation 111.75 - 168.25 MHz	-	21	55	ns p-p
Absolute Delay	-	0.539	-	μsec
Relative Attenuation ⁽⁵⁾				
15 - 75 MHz	45	51	-	dB
75 - 98 MHz	40	50	-	dB
182 - 205 MHz	40	43	-	dB
205 - 350 MHz	45	50	-	dB
Terminating Source Impedance ⁽⁶⁾	-	50	-	Ω
Terminating Load Impedance ⁽⁶⁾	-	50	-	Ω
Substrate Material	-	128 LiNbO ₃	-	-
Temperature Coefficient of Frequency	-	-74	-	ppm/°C

Notes:

1. All specifications are based on the TriQuint test circuit shown below
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature and manufacturing tolerances
4. Typical values are based on average measurements at room temperature
5. All attenuation measurements are measured relative to minimum insertion loss
6. This is the optimum impedance in order to achieve the performance shown

Test Circuit:

Actual matching values may vary due to PCB layout and parasitics



Electrical Specifications ⁽¹⁾

Operating Temperature Range: ⁽²⁾ -40 to +85 °C

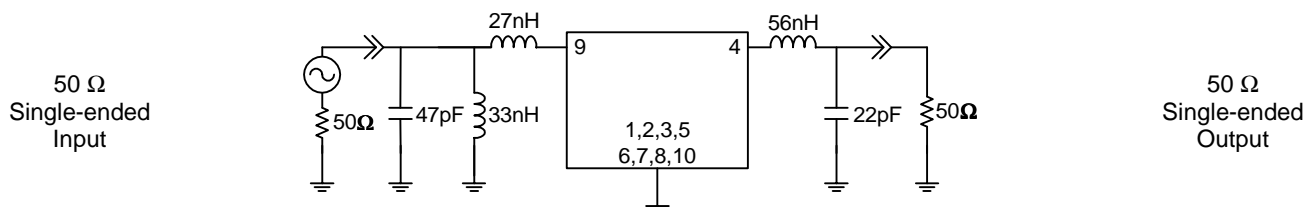
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Notes:

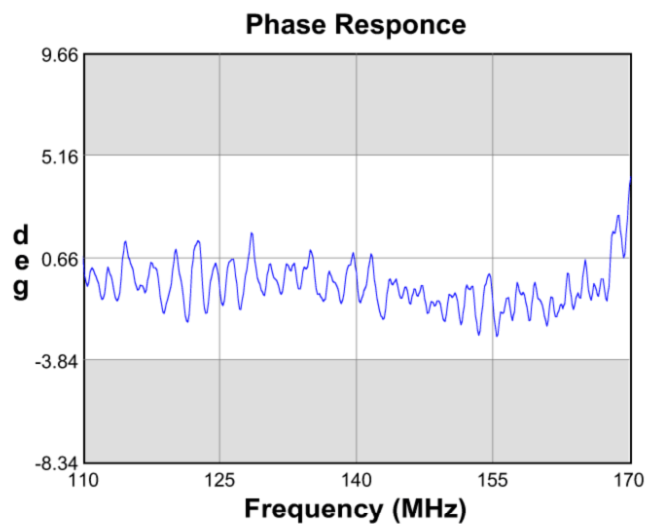
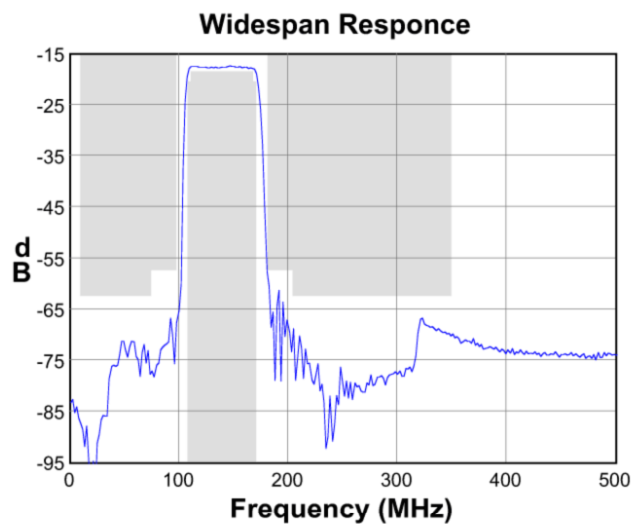
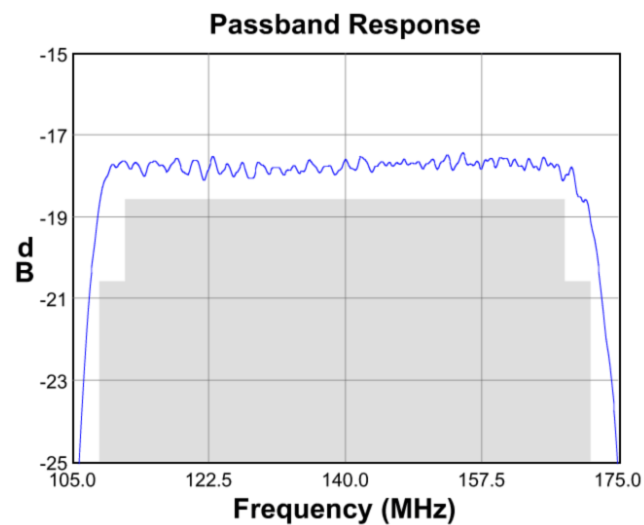
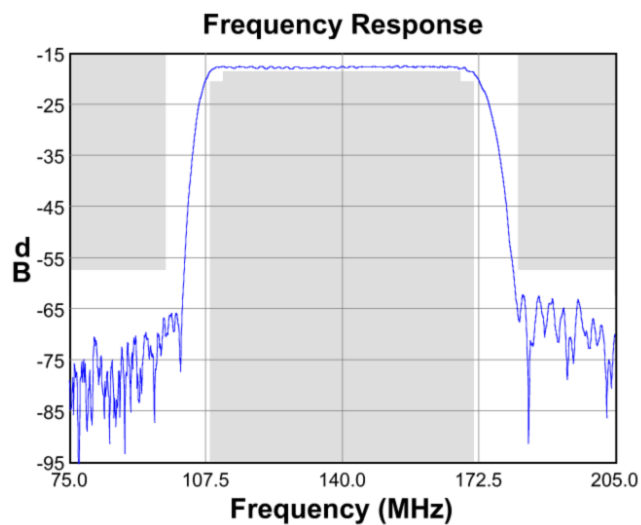
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Test Circuit:

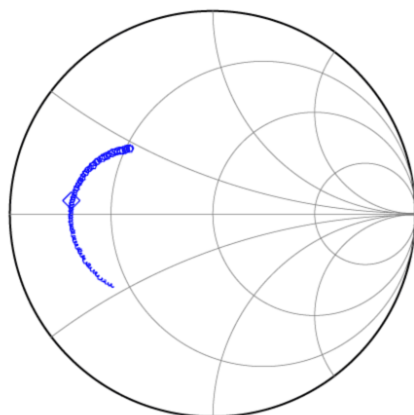
Actual matching values may vary due to PCB layout and parasitics



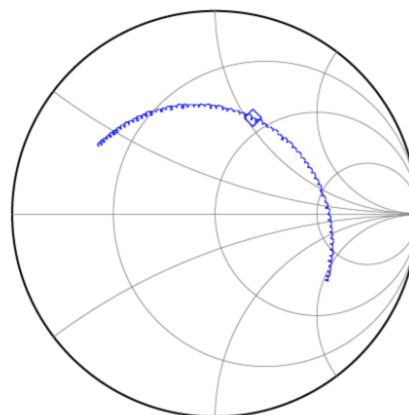
Typical Performance (at room temperature)



Input Smith Chart

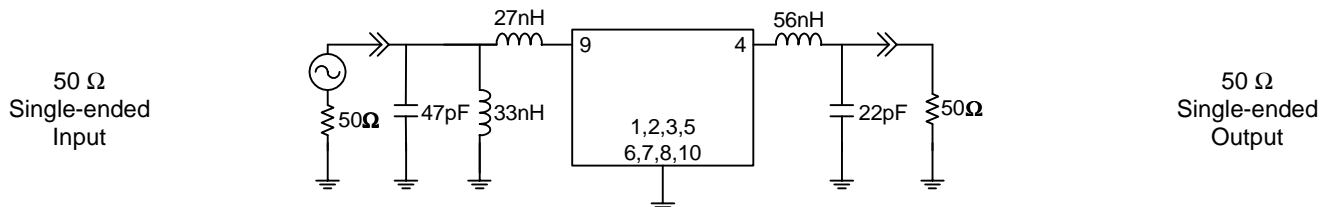


Output Smith Chart

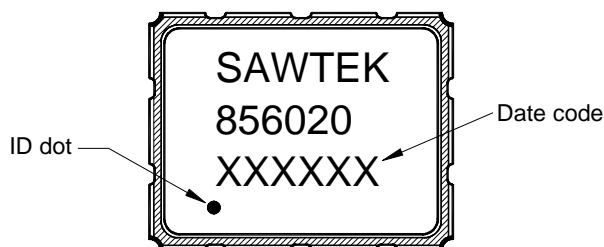


Matching Schematics

Actual matching values may vary due to PCB layout and parasitics

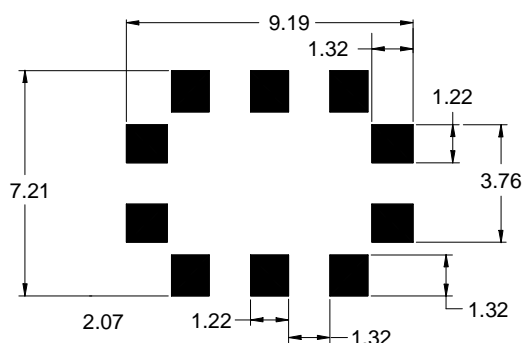


Marking



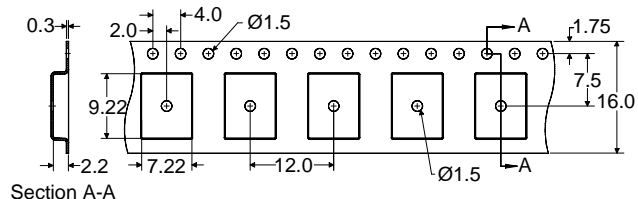
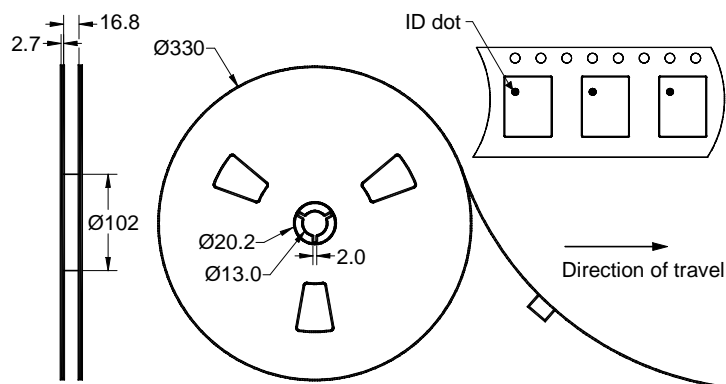
The date code consists of: day of the current year (Julian, 3 digits), last digit of the year (1 digit) and hour (2 digits)

PCB Footprint



This footprint represents a recommendation only
Dimensions shown are nominal in millimeters

Tape and Reel




Dimensions shown are nominal in millimeters
Packaging quantity: 2000 units/reel

Maximum Ratings


Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-40	+85	°C
Storage Temperature Range	T _{stg}	-40	+85	°C

Important Notes

Warnings

- Electrostatic Sensitive Device (ESD) 
- Avoid ultrasonic exposure

RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS) 

Solderability

- Compatible with JESD22-B102, Pb-free process, 260C peak reflow temperature ([see soldering profile](#))

Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

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[Representatives or distributors](#)